

# Description

This device is an ultra low capacitance PESD product designed to protect very high speed data interfaces. MLSEP15B-0603 has a typical capacitance of only 0.05pf (I/O to GND), and it can be used to meet the ESD immunity requirements of IEC61000-4-2 (15KV air, 8KV contact discharge).

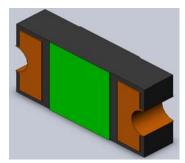
### Feature

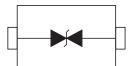
- ESD protection for high speed data lines to IEC61000-4-2
- ESD contact discharge typical 8KV, max 15KV
- ESD air discharge typical 15KV, max 25KV
- Multilayer structure
- Surface mount
- Extremely low capacitance
- Very low leakage current
- Fast response time
- Bi-directional ESD protection
- Lead free solder termination
- The best ESD protection for high frequency, low voltage applications

# Application

- High Definition Multi-Media Interface (HDMI)
- Digital Visual Interface (DVI)
- Display Port Interface (DP)
- Unified Display Interface (UDI)
- Mobile Display Digital Interface (MDDI)
- Gigabit Ethernet
- USB2.0 and USB3.0
- IEEE1394 interface

# MLSEP15B-0603





Schematic Diagram



### **Absolute Maximum Ratings**

Parameter	Symbol	Value	Unit
Maximum Contact discharge voltage Per IEC61000-4-2		15KV	V
Maximum Air discharge voltage Per IEC61000-4-2		25KV	V
Maximum Operating temperature	Toper	-55 to +125	°C
Maximum Storage temperature	Тѕтс	-25 to +35	°C
Maximum lead temperature for soldering during 10s	T∟	260	°C

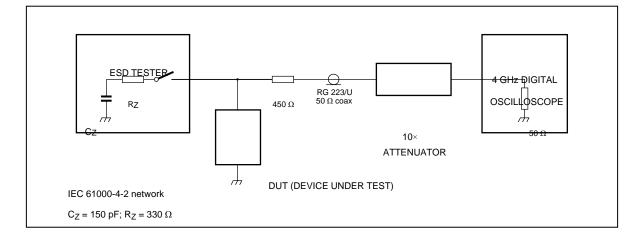
# Electrical Characteristics(T<sub>A</sub>=25°C)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Rated Voltage	VR				15	V
Trigger voltage	VT	IEC61000-4-2 8KV contact discharge		300		V
Clamping voltage	Vc	IEC61000-4-2 8KV contact discharge		35		V
Leakage current	IL .	DC 15V shall be applied on component		0.01	0.1	μA
Capacitance	СР	$V_R = 0V, f = 1MHz$		0.05		pF

Notes: 1, Trigger and clamping voltage are measured per IEC 61000-4-2, 8KV contact discharge method.

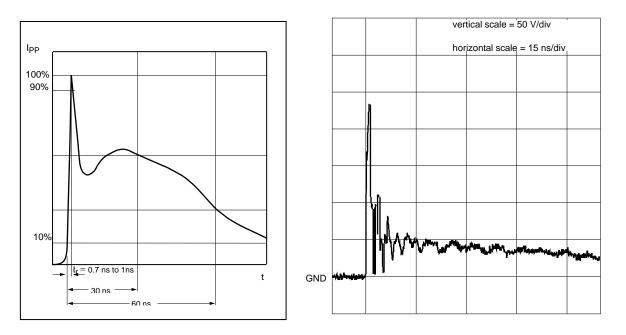
2, After reliability tests such as high Temp storage, Temp cycles, continuous ESD strike etc, the maximum leakage current is less than 10uA.

# **ESD Clamping Test**

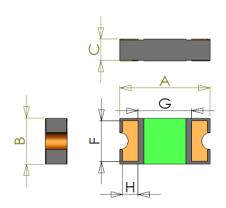




# **ESD Clamping Test Waveforms**

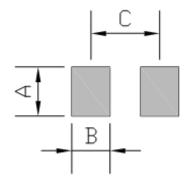


### **Product Dimension**



Symbol	I	Unit		
Symbol	Min	Тур	Max	Unit
А	1.50	1.60	1.70	
В	0.74	0.82	0.90	
С	0.32	0.36	0.40	
н	0.265	0.285	0.305	mm
F	0.70	0.72	0.74	
G	0.93	0.95	0.97	

### **PAD Dimension**



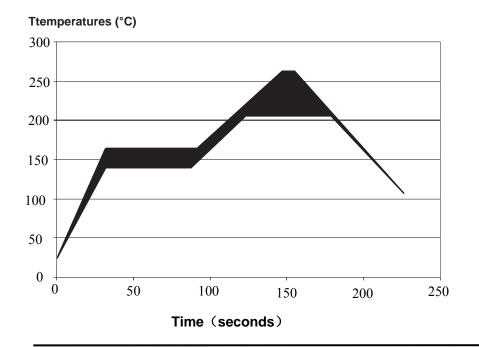
Symbol	Dimension	Unit
A	0.95	
В	0.65	mm
С	1.35	

Solder thickness 0.08 to 0.12mm

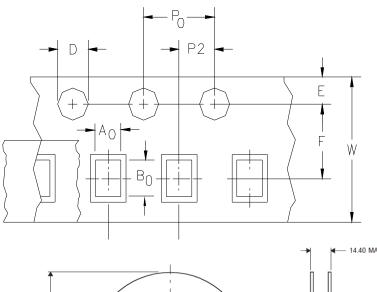
Multilayer Polymer ESD Suppressor



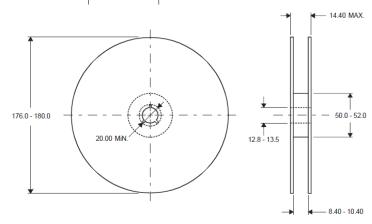
### **Solder Reflow Recommendations**



# **Package Information**



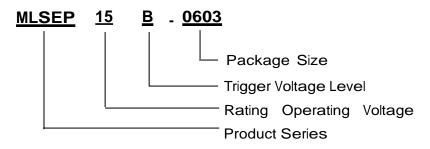
Dimension	Typical	Unit
A0	1.00	
В0	1.90	
D	1.55	
P0	4.00	
P1	4.00	
P2	2.00	mm
Е	1.75	
F	3.50	
W	8.00	



DIMENSIONS ARE: MILLIMETERS



# Part Number System



### **Order Information**

Device	Package	Net Weight	Carrier	Quantity	HSF Status
MLSEP15B-0603	1608	1.00 mg	Tape & Reel	5,000pcs/reel	RoHS compliant

# **Revision history**

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Date	Revision	Description of changes
14-Dec-2016	3.0	Adjust pad dimension

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#### 5